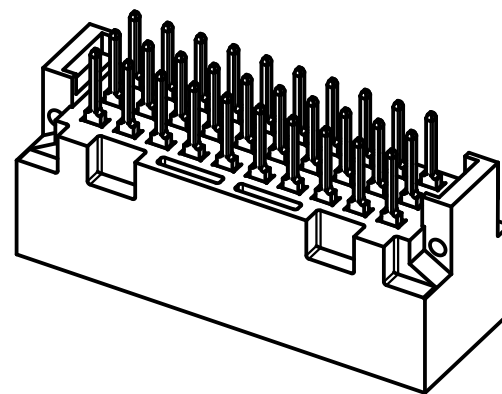
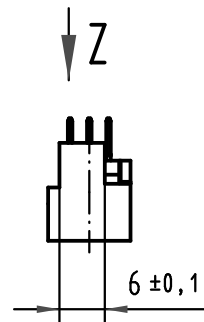
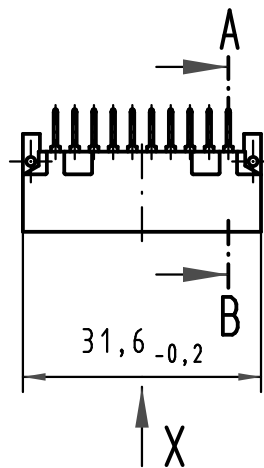
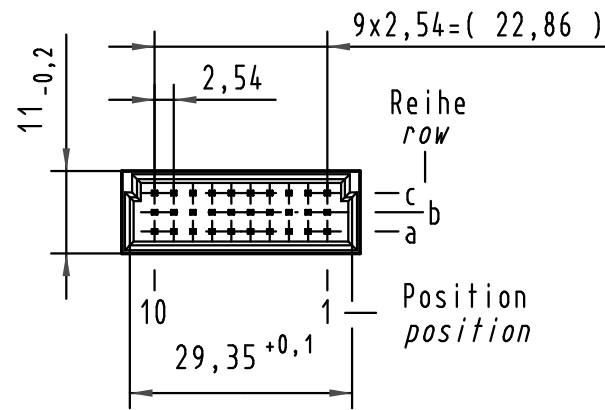
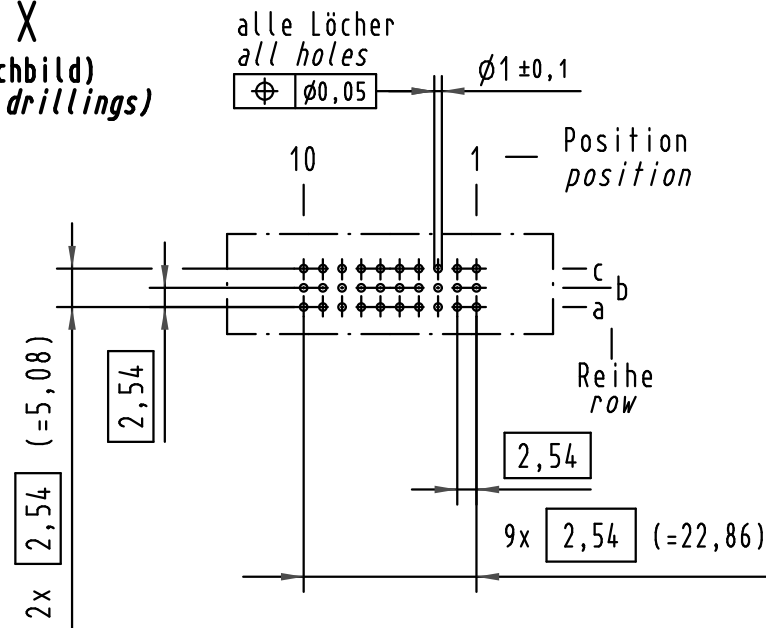
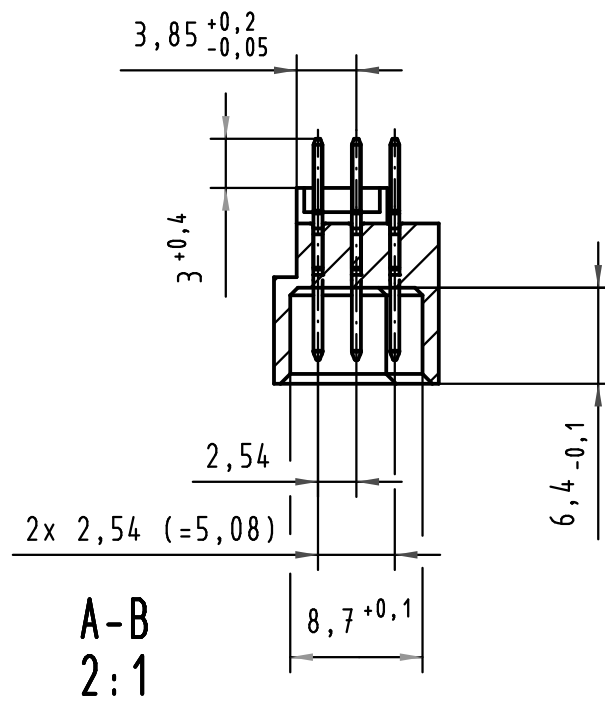
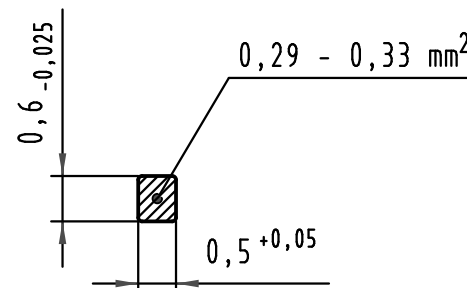


**X**  
(Lochbild)  
(board drillings)

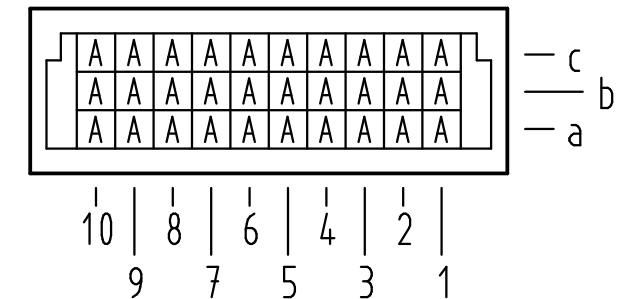


**Z**  
10:1

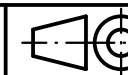
Querschnitt der  
Lötanschlüsse:  
cross-section of  
solder terminations:



**X** Kontaktbelegung  
contact loading



|                         |                                                             |                                      |
|-------------------------|-------------------------------------------------------------|--------------------------------------|
| 09 25 130 6590          | 2                                                           | Au flash over PdNi over Ni           |
| Bestell-Nr.<br>part-no. | Anforderungsstufe nach IEC<br>performance level acc. to IEC | Kontaktoberfläche<br>contact plating |



All Dimensions in mm  
Original Size DIN A 3

Techn. Character.

Detail. 05.05.09 MR  
Insp. 05.05.09 RA  
Stand.

HARTING Electronics GmbH & Co. KG  
D-32339 ESPELKAMP

Nicht tolerierte Maße/Free size tolerances  
IEC 60603-2

Bauform 3C Messerleiste ohne Flansch  
Einlöt , 30 pol., SMC (Hochtemperatur)  
type 3C male connector without flange  
solder , 30 pol., SMC (high temperature)

TB 09 25 130 x590

Blatt/ page



Sub.

35605  
Mod.

Dat.

Name